

Vishay Siliconix

# N-Channel 40-V (D-S) MOSFET

PRODUCT SUMMARY					
V <sub>DS</sub> (V)	$r_{DS(on)}\left(\Omega\right)$	I <sub>D</sub> (A) <sup>a</sup>	Q <sub>g</sub> (Typ.)		
40	0.037 at V <sub>GS</sub> = 10 V	8	5.3 nC		
	$0.046$ at $V_{GS} = 4.5 \text{ V}$	8	5.5 110		

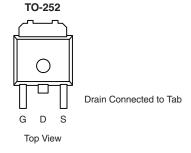
### **FEATURES**

- TrenchFET® Power MOSFET
- 100 % UIS Tested

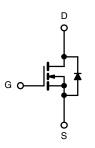


### **APPLICATIONS**

- · Backlight Inverter for LCD Display
- Full Bridge DC/DC Converter



Ordering Information: SUD50N04-37P-E3 (Lead (Pb)-free)



N-Channel MOSFET

<b>ABSOLUTE MAXIMUM RATINGS</b>	$T_A = 25  ^{\circ}C$ , unles	s otherwise no	oted		
Parameter	Symbol	Limit	Unit		
Drain-Source Voltage	$V_{DS}$	40	V		
Gate-Source Voltage	$V_{GS}$	± 20			
	T <sub>C</sub> = 25 °C		8 <sup>a</sup>		
Continuous Drain Current (T <sub>.1</sub> = 150 °C)	T <sub>C</sub> = 70 °C		8 <sup>a</sup>		
Continuous Diain Current (1) = 150 C)	T <sub>A</sub> = 25 °C	I <sub>D</sub>	5.4 <sup>b</sup>		
	T <sub>A</sub> = 70 °C		4.4 <sup>b</sup>	A	
Pulsed Drain Current		I <sub>DM</sub>	30		
Continuous Source-Drain Diode Current	T <sub>C</sub> = 25 °C	1	8 <sup>a</sup>		
Continuous Source-Drain Diode Current	T <sub>A</sub> = 25 °C	l <sub>S</sub>	1.6 <sup>b</sup>		
Single Pulse Avalanche Current L = 0.1 mH		I <sub>AS</sub>	7		
Avalanche Energy	L = 0.1 IIII1	E <sub>AS</sub>	2.45	mJ	
	T <sub>C</sub> = 25 °C	P <sub>D</sub>	10.8	w	
Maximum Power Dissipation	T <sub>C</sub> = 70 °C		6.9		
	T <sub>A</sub> = 25 °C	' D	2.0 <sup>b</sup>		
	T <sub>A</sub> = 70 °C		1.3 <sup>b</sup>	1	
Operating Junction and Storage Temperature Ra	T <sub>J</sub> , T <sub>stg</sub>	- 55 to 150	°C		

THERMAL RESISTANCE RATINGS						
Parameter		Symbol	Typical	Maximum	Unit	
Maximum Junction-to-Ambient <sup>b</sup>	Steady State	$R_{thJA}$	49	60	°C/W	
Maximum Junction-to-Case	Steady State	R <sub>thJC</sub>	9.4	11.5		

## Notes:

a. Package limited.

b. Surface mounted on 1" x 1" FR4 board.

# SUD50N04-37P

# Vishay Siliconix



Parameter	Symbol	Test Conditions	Min.	Тур.	Max.	Unit	
Static							
Drain-Source Breakdown Voltage	V <sub>DS</sub>	$V_{GS} = 0 \text{ V}, I_D = 1 \text{ mA}$	40			V	
V <sub>DS</sub> Temperature Coefficient	$\Delta V_{DS}/T_{J}$			44		mV/°C	
V <sub>GS(th)</sub> Temperature Coefficient	$\Delta V_{GS(th)}/T_J$	$I_D = 250 \mu A$		- 5.5			
Gate-Source Threshold Voltage	V <sub>GS(th)</sub>	$V_{DS} = V_{GS}, I_{D} = 250 \mu\text{A}$	1.4		2.5	V	
Gate-Source Leakage	I <sub>GSS</sub>	$V_{DS} = 0 \text{ V}, V_{GS} = \pm 20 \text{ V}$			± 100	nA	
7 0 1 1/1 5 1 0 1	I <sub>DSS</sub>	V <sub>DS</sub> = 40 V, V <sub>GS</sub> = 0 V			1	1 20 μA	
Zero Gate Voltage Drain Current		V <sub>DS</sub> = 40 V, V <sub>GS</sub> = 0 V, T <sub>J</sub> = 70 °C			20		
On-State Drain Current <sup>a</sup>	I <sub>D(on)</sub>	$V_{DS} \ge 5 \text{ V}, V_{GS} = 10 \text{ V}$	10			Α	
Drain-Source On-State Resistance <sup>a</sup>		V <sub>GS</sub> = 10 V, I <sub>D</sub> = 5 A		0.0305	0.037	Ω	
	r <sub>DS(on)</sub>	$V_{GS} = 4.5 \text{ V}, I_D = 4 \text{ A}$		0.037	0.046		
Forward Transconductance <sup>a</sup>	9 <sub>fs</sub>	V <sub>DS</sub> = 15 V, I <sub>D</sub> = 5 A		22		S	
Dynamic <sup>b</sup>							
Input Capacitance	C <sub>iss</sub>			640		pF	
Output Capacitance	C <sub>oss</sub>	$V_{DS} = 20 \text{ V}, V_{GS} = 0 \text{ V}, f = 1 \text{ MHz}$		73			
Reverse Transfer Capacitance	C <sub>rss</sub>			41			
Total Cata Chausa		$V_{DS} = 20 \text{ V}, V_{GS} = 10 \text{ V}, I_D = 5 \text{ A}$		11.7	20		
Total Gate Charge	$Q_g$	3.0		5.3	9	nC	
Gate-Source Charge	$Q_{gs}$	$V_{DS} = 20 \text{ V}, V_{GS} = 4.5 \text{ V}, I_D = 5 \text{ A}$		1.9			
Gate-Drain Charge	Q <sub>gd</sub>			1.7			
Gate Resistance	$R_{g}$	f = 1 MHz		2.2		Ω	
Turn-On Delay Time	t <sub>d(on)</sub>			18	30	ns	
Rise Time	t <sub>r</sub>	$V_{DD} = 20 \text{ V}, R_L = 4 \Omega$		14	25		
Turn-Off Delay Time	t <sub>d(off)</sub>	$I_D \cong 5 \text{ A}, V_{GEN} = 4.5 \text{ V}, R_g = 1 \Omega$		14	25		
Fall Time	t <sub>f</sub>			10	20		
Turn-On Delay Time	t <sub>d(on)</sub>			9	18		
Rise Time	t <sub>r</sub>	$V_{DD} = 20 \text{ V}, R_L = 4 \Omega$		11	20		
Turn-Off Delay Time	t <sub>d(off)</sub>	$I_D \cong 5 \text{ A}, V_{GEN} = 10 \text{ V}, R_g = 1 \Omega$		14	25		
Fall Time	t <sub>f</sub>			8	18		
<b>Drain-Source Body Diode Characteris</b>	tics						
Continuous Source-Drain Diode Current	I <sub>S</sub>	T <sub>C</sub> = 25 °C			8	Α	
Pulse Diode Forward Current <sup>a</sup>	I <sub>SM</sub>				30		
Body Diode Voltage	$V_{SD}$	I <sub>S</sub> = 2 A		0.805	1.2	V	
Body Diode Reverse Recovery Time	t <sub>rr</sub>			19	30	ns	
Body Diode Reverse Recovery Charge	Q <sub>rr</sub>			14	25	nC	
Reverse Recovery Fall Time	t <sub>a</sub>	$I_F = 2 \text{ A}, \text{ di/dt} = 100 \text{ A/}\mu\text{s}, T_J = 25 ^{\circ}\text{C}$		13		ns	
Reverse Recovery Rise Time	t <sub>b</sub>			6			

### Notes:

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

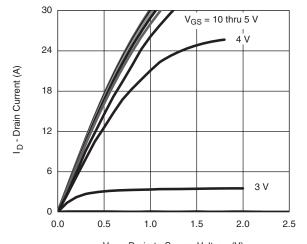
a. Pulse test; pulse width  $\leq$  300  $\mu s,$  duty cycle  $\leq$  2 %.

b. Guaranteed by design, not subject to production testing.



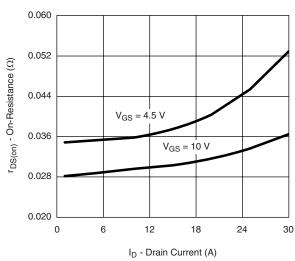
Vishay Siliconix

## TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted

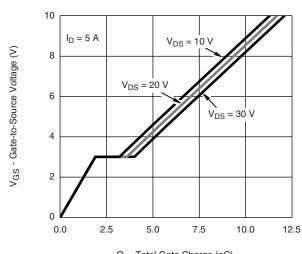


 $V_{\mbox{\scriptsize DS}}$  - Drain-to-Source Voltage (V)

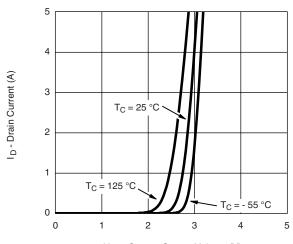
### **Output Characteristics**



On-Resistance vs. Drain Current

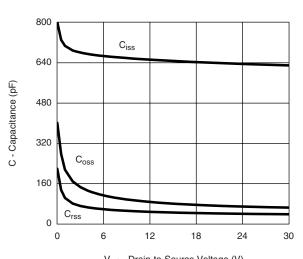


Q<sub>g</sub> - Total Gate Charge (nC) **Gate Charge** 



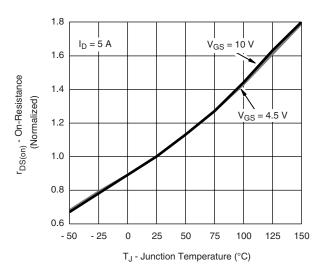
V<sub>GS</sub> - Gate-to-Source Voltage (V)

#### **Transfer Characteristics**



V<sub>DS</sub> - Drain-to-Source Voltage (V)

### Capacitance



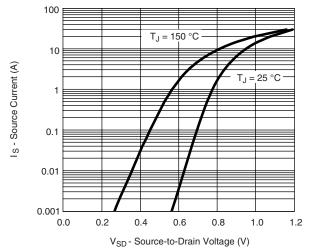
On-Resistance vs. Junction Temperature

# SUD50N04-37P

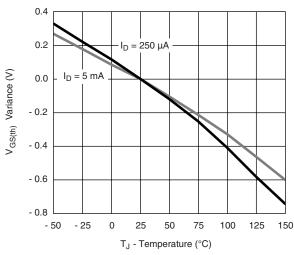
# Vishay Siliconix

# VISHAY.

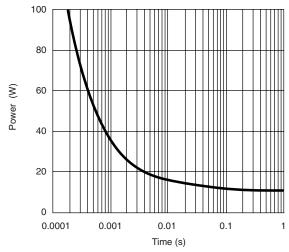
## TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



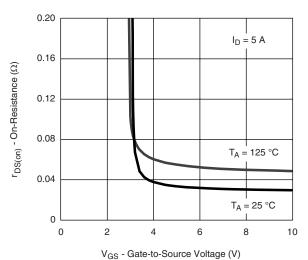
Source-Drain Diode Forward Voltage



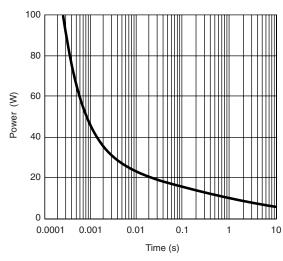
**Threshold Voltage** 



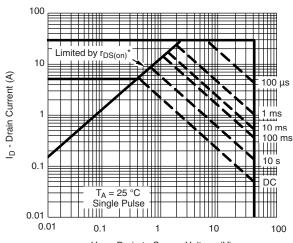
Single Pulse Power, Junction-to-Case



On-Resistance vs. Gate-to-Source Voltage



Single Pulse Power, Junction-to-Ambient



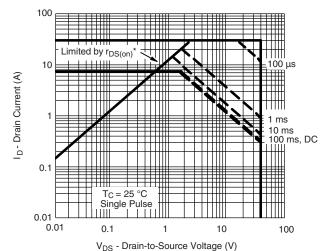
 $$V_{DS}$$  - Drain-to-Source Voltage (V)  $^*$   $V_{GS}$  > minimum  $V_{GS}$  at which  $r_{DS(on)}$  is specified

Safe Operating Area, Junction-to-Ambient



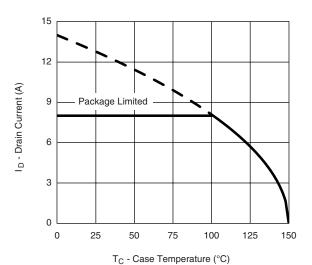
Vishay Siliconix

## TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted

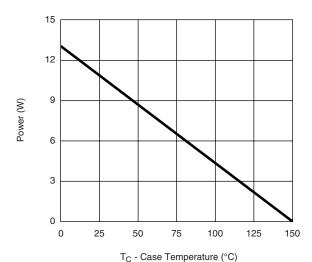


\* V<sub>GS</sub> > minimum V<sub>GS</sub> at which r<sub>DS(on)</sub> is specified

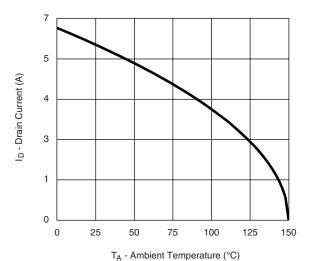
#### Safe Operating Area, Junction-to-Case



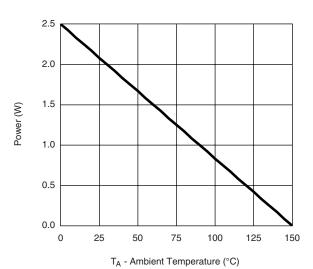
Current Derating\*, Junction-to-Case



Power Derating\*, Junction-to-Case



Current Derating\*, Junction-to-Ambient



Power Derating\*, Junction-to-Ambient

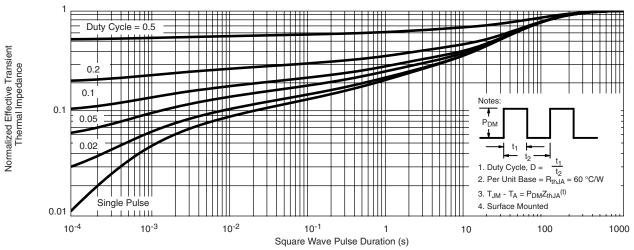
 $<sup>^{\</sup>star}$  The power dissipation  $P_D$  is based on  $T_{J(max)}=175\,^{\circ}\text{C}$ , using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit.

# SUD50N04-37P

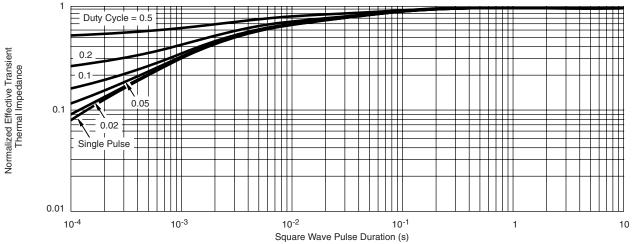
# Vishay Siliconix

# VISHAY.

### TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



### Normalized Thermal Transient Impedance, Junction-to-Ambient



Normalized Thermal Transient Impedance, Junction-to-Case

Vishay Siliconix maintains worldwide manufacturing capability. Products may be manufactured at one of several qualified locations. Reliability data for Silicon Technology and Package Reliability represent a composite of all qualified locations. For related documents such as package/tape drawings, part marking, and reliability data, see <a href="http://www.vishay.com/ppg?69732">http://www.vishay.com/ppg?69732</a>.



## **Legal Disclaimer Notice**

Vishay

## **Disclaimer**

ALL PRODUCT, PRODUCT SPECIFICATIONS AND DATA ARE SUBJECT TO CHANGE WITHOUT NOTICE TO IMPROVE RELIABILITY, FUNCTION OR DESIGN OR OTHERWISE.

Vishay Intertechnology, Inc., its affiliates, agents, and employees, and all persons acting on its or their behalf (collectively, "Vishay"), disclaim any and all liability for any errors, inaccuracies or incompleteness contained in any datasheet or in any other disclosure relating to any product.

Vishay makes no warranty, representation or guarantee regarding the suitability of the products for any particular purpose or the continuing production of any product. To the maximum extent permitted by applicable law, Vishay disclaims (i) any and all liability arising out of the application or use of any product, (ii) any and all liability, including without limitation special, consequential or incidental damages, and (iii) any and all implied warranties, including warranties of fitness for particular purpose, non-infringement and merchantability.

Statements regarding the suitability of products for certain types of applications are based on Vishay's knowledge of typical requirements that are often placed on Vishay products in generic applications. Such statements are not binding statements about the suitability of products for a particular application. It is the customer's responsibility to validate that a particular product with the properties described in the product specification is suitable for use in a particular application. Parameters provided in datasheets and / or specifications may vary in different applications and performance may vary over time. All operating parameters, including typical parameters, must be validated for each customer application by the customer's technical experts. Product specifications do not expand or otherwise modify Vishay's terms and conditions of purchase, including but not limited to the warranty expressed therein.

Except as expressly indicated in writing, Vishay products are not designed for use in medical, life-saving, or life-sustaining applications or for any other application in which the failure of the Vishay product could result in personal injury or death. Customers using or selling Vishay products not expressly indicated for use in such applications do so at their own risk. Please contact authorized Vishay personnel to obtain written terms and conditions regarding products designed for such applications.

No license, express or implied, by estoppel or otherwise, to any intellectual property rights is granted by this document or by any conduct of Vishay. Product names and markings noted herein may be trademarks of their respective owners.